

## 74ABT273 Octal D-Type Flip-Flop

### General Description

The ABT273 has eight edge-triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered Clock (CP) and Master Reset ( $\overline{MR}$ ) inputs load and reset (clear) all flip-flops simultaneously.

The register is fully edge-triggered. The state of each D input, one setup time before the LOW-to-HIGH clock transition, is transferred to the corresponding flip-flop's Q output.

All outputs will be forced LOW independently of Clock or Data inputs by a LOW voltage level on the  $\overline{MR}$  input. The device is useful for applications where the true output only is required and the Clock and Master Reset are common to all storage elements.

### Features

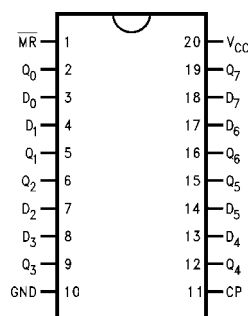
- Eight edge-triggered D-type flip-flops
- Buffered common clock
- Buffered, asynchronous Master Reset
- See ABT377 for clock enable version
- See ABT373 for transparent latch version
- See ABT374 for 3-STATE version
- Output sink capability of 64 mA, source capability of 32 mA
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability
- Disable time less than enable time to avoid bus contention

### Ordering Code:

| Order Number | Package Number | Package Description                                                             |
|--------------|----------------|---------------------------------------------------------------------------------|
| 74ABT273CSC  | M20B           | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide Body |
| 74ABT273CSJ  | M20D           | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide                   |
| 74ABT273CMSA | MSA20          | 20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide           |
| 74ABT273CMTC | MTC20          | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide     |

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

### Connection Diagram



### Pin Descriptions

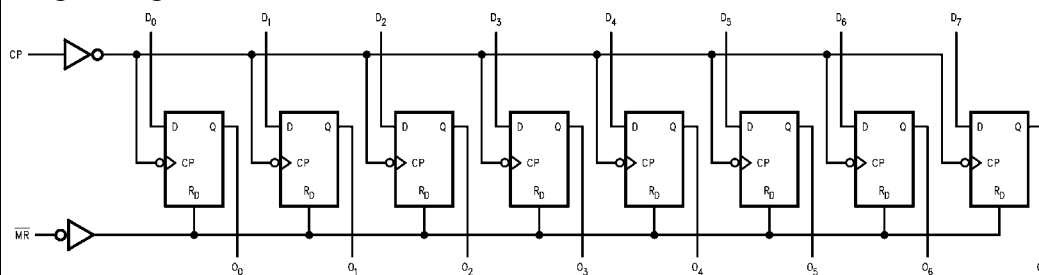
| Pin Names                      | Description                            |
|--------------------------------|----------------------------------------|
| D <sub>0</sub> –D <sub>7</sub> | Data Inputs                            |
| $\overline{MR}$                | Master Reset (Active LOW)              |
| CP                             | Clock Pulse Input (Active Rising Edge) |
| Q <sub>0</sub> –Q <sub>7</sub> | Data Outputs                           |

## Truth Table

| Operating Mode | Inputs                 |            |              | Output       |
|----------------|------------------------|------------|--------------|--------------|
|                | $\overline{\text{MR}}$ | CP         | $\text{D}_n$ | $\text{Q}_n$ |
| Reset (Clear)  | L                      | X          | X            | L            |
| Load "1"       | H                      | $\nearrow$ | h            | H            |
| Load "0"       | H                      | $\nearrow$ | l            | L            |

H = HIGH Voltage Level steady state  
 h = HIGH Voltage Level one setup time prior to the LOW-to-HIGH clock transition  
 L = LOW Voltage Level steady state  
 l = LOW Voltage Level one setup time prior to the LOW-to-HIGH clock transition  
 X = Immaterial  
 $\nearrow$  = LOW-to-HIGH clock transition

## Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

**Absolute Maximum Ratings**(Note 1)

|                                                                        |                                      |
|------------------------------------------------------------------------|--------------------------------------|
| Storage Temperature                                                    | –65°C to +150°C                      |
| Ambient Temperature under Bias                                         | –55°C to +125°C                      |
| Junction Temperature under Bias                                        | –55°C to +150°C                      |
| V <sub>CC</sub> Pin Potential to Ground Pin                            | –0.5V to +7.0V                       |
| Input Voltage (Note 2)                                                 | –0.5V to +7.0V                       |
| Input Current (Note 2)                                                 | –30 mA to +5.0 mA                    |
| Voltage Applied to Any Output<br>in the Disabled or<br>Power-Off State | –0.5V to +4.75V                      |
| in the HIGH State                                                      | –0.5V to V <sub>CC</sub>             |
| Current Applied to Output<br>in LOW State (Max)                        | twice the rated I <sub>OL</sub> (mA) |
| DC Latchup Source Current<br>(Across Comm Operating Range)             | –500 mA                              |
| Over Voltage Latchup                                                   | V <sub>CC</sub> + 4.5V               |

**Recommended Operating Conditions**

|                                                 |                |
|-------------------------------------------------|----------------|
| Free Air Ambient Temperature                    | –40°C to +85°C |
| Supply Voltage                                  | +4.5V to +5.5V |
| Minimum Input Edge Rate ( $\Delta V/\Delta t$ ) |                |
| Data Input                                      | 50 mV/ns       |
| Enable Input                                    | 20 mV/ns       |

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

**DC Electrical Characteristics**

| Symbol           | Parameter                                           | Min        | Typ | Max      | Units      | V <sub>CC</sub> | Conditions                                                                                                                            |
|------------------|-----------------------------------------------------|------------|-----|----------|------------|-----------------|---------------------------------------------------------------------------------------------------------------------------------------|
| V <sub>IH</sub>  | Input HIGH Voltage                                  | 2.0        |     |          | V          |                 | Recognized HIGH Signal                                                                                                                |
| V <sub>IL</sub>  | Input LOW Voltage                                   |            |     | 0.8      | V          |                 | Recognized LOW Signal                                                                                                                 |
| V <sub>CD</sub>  | Input Clamp Diode Voltage                           |            |     | –1.2     | V          | Min             | I <sub>IN</sub> = –18 mA                                                                                                              |
| V <sub>OH</sub>  | Output HIGH Voltage                                 | 2.5<br>2.0 |     |          | V          | Min             | I <sub>OH</sub> = –3 mA<br>I <sub>OH</sub> = –32 mA                                                                                   |
| V <sub>OL</sub>  | Output LOW Voltage                                  |            |     | 0.55     | V          | Min             | I <sub>OL</sub> = 64 mA                                                                                                               |
| I <sub>IH</sub>  | Input HIGH Current                                  |            |     | 1<br>1   | μA         | Max             | V <sub>IN</sub> = 2.7V (Note 3)<br>V <sub>IN</sub> = V <sub>CC</sub>                                                                  |
| I <sub>BVI</sub> | Input HIGH Current<br>Breakdown Test                |            |     | 7        | μA         | Max             | V <sub>IN</sub> = 7.0V                                                                                                                |
| I <sub>IL</sub>  | Input LOW Current                                   |            |     | –1<br>–1 | μA         | Max             | V <sub>IN</sub> = 0.5V (Note 3)<br>V <sub>IN</sub> = 0.0V                                                                             |
| V <sub>ID</sub>  | Input Leakage Test                                  | 4.75       |     |          | V          | 0.0             | I <sub>ID</sub> = 1.9 μA<br>All Other Pins Grounded                                                                                   |
| I <sub>OS</sub>  | Output Short-Circuit Current                        | –100       |     | –275     | mA         | Max             | V <sub>OUT</sub> = 0.0V                                                                                                               |
| I <sub>CEX</sub> | Output HIGH Leakage Current                         |            |     | 50       | μA         | Max             | V <sub>OUT</sub> = V <sub>CC</sub>                                                                                                    |
| I <sub>CCH</sub> | Power Supply Current                                |            |     | 50       | μA         | Max             | All Outputs HIGH                                                                                                                      |
| I <sub>CCL</sub> | Power Supply Current                                |            |     | 30       | mA         | Max             | All Outputs LOW                                                                                                                       |
| I <sub>CCT</sub> | Maximum I <sub>CC</sub> /Input      Outputs Enabled |            |     | 1.5      | mA         | Max             | V <sub>I</sub> = V <sub>CC</sub> – 2.1V<br>Data Input V <sub>I</sub> = V <sub>CC</sub> – 2.1V<br>All Others at V <sub>CC</sub> or GND |
| I <sub>CCD</sub> | Dynamic I <sub>CC</sub> No Load                     |            |     | 0.3      | mA/<br>MHz | Max             | Outputs Open (Note 4)<br>One Bit Toggling, 50% Duty Cycle                                                                             |

**Note 3:** Guaranteed but not tested.

**Note 4:** For 8 bits toggling, I<sub>CCD</sub> < 0.5 mA/MHz.

## AC Electrical Characteristics

(SSOIC package)

| Symbol           | Parameter                                 | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |     |     | T <sub>A</sub> = -55°C to +125°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | T <sub>A</sub> = -40°C to +85°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | Units |
|------------------|-------------------------------------------|-----------------------------------------------------------------------------|-----|-----|----------------------------------------------------------------------------------------------|-----|---------------------------------------------------------------------------------------------|-----|-------|
|                  |                                           | Min                                                                         | Typ | Max | Min                                                                                          | Max | Min                                                                                         | Max |       |
| f <sub>MAX</sub> | Maximum Clock Frequency                   | 150                                                                         | 200 |     | 150                                                                                          |     | 150                                                                                         |     | MHz   |
| t <sub>PLH</sub> | Propagation Delay<br>CP to O <sub>n</sub> | 2.0                                                                         |     | 6.0 | 1.0                                                                                          | 7.0 | 2.0                                                                                         | 6.0 | ns    |
| t <sub>PHL</sub> | Propagation Delay<br>MR to O <sub>n</sub> | 2.8                                                                         |     | 6.8 | 1.0                                                                                          | 7.5 | 2.8                                                                                         | 6.8 | ns    |
| t <sub>PHL</sub> | Propagation Delay<br>MR to O <sub>n</sub> | 2.5                                                                         |     | 7.4 | 1.0                                                                                          | 8.2 | 2.5                                                                                         | 7.4 | ns    |

## AC Operating Requirements

| Symbol             | Parameter                        | T <sub>A</sub> = +25°C<br>V <sub>CC</sub> = +5.0V<br>C <sub>L</sub> = 50 pF |     | T <sub>A</sub> = -55°C to +125°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | T <sub>A</sub> = -40°C to +85°C<br>V <sub>CC</sub> = 4.5V to 5.5V<br>C <sub>L</sub> = 50 pF |     | Units |
|--------------------|----------------------------------|-----------------------------------------------------------------------------|-----|----------------------------------------------------------------------------------------------|-----|---------------------------------------------------------------------------------------------|-----|-------|
|                    |                                  | Min                                                                         | Max | Min                                                                                          | Max | Min                                                                                         | Max |       |
| t <sub>S</sub> (H) | Setup Time, HIGH                 | 2.0                                                                         |     | 2.0                                                                                          |     | 2.0                                                                                         |     | ns    |
| t <sub>S</sub> (L) | or LOW D <sub>n</sub> to CP      | 2.5                                                                         |     | 2.5                                                                                          |     | 2.5                                                                                         |     | ns    |
| t <sub>H</sub> (H) | Hold Time, HIGH                  | 1.2                                                                         |     | 1.4                                                                                          |     | 1.2                                                                                         |     | ns    |
| t <sub>H</sub> (L) | or LOW D <sub>n</sub> to CP      | 1.2                                                                         |     | 1.4                                                                                          |     | 1.2                                                                                         |     | ns    |
| t <sub>W</sub> (H) | Pulse Width, CP,                 | 3.3                                                                         |     | 3.3                                                                                          |     | 3.3                                                                                         |     | ns    |
| t <sub>W</sub> (L) | HIGH or LOW                      | 3.3                                                                         |     | 3.3                                                                                          |     | 3.3                                                                                         |     | ns    |
| t <sub>W</sub> (L) | Master Reset Pulse<br>Width, LOW | 3.3                                                                         |     | 3.3                                                                                          |     | 3.3                                                                                         |     | ns    |
| t <sub>REC</sub>   | Recovery Time<br>MR to CP        | 2.0                                                                         |     | 2.0                                                                                          |     | 2.0                                                                                         |     | ns    |

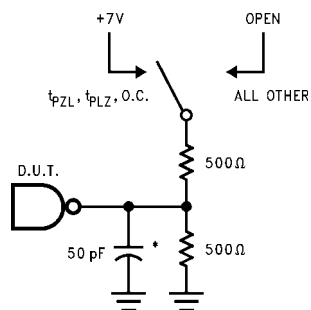
## Capacitance

(SOIC package)

| Symbol                    | Parameter          | Typ | Units | Conditions<br>T <sub>A</sub> = 25°C |
|---------------------------|--------------------|-----|-------|-------------------------------------|
| C <sub>IN</sub>           | Input Capacitance  | 5   | pF    | V <sub>CC</sub> = 0V                |
| C <sub>OUT</sub> (Note 5) | Output Capacitance | 9   | pF    | V <sub>CC</sub> = 5.0V              |

**Note 5:** C<sub>OUT</sub> is measured at frequency f = 1 MHz, per MIL-STD-883C, Method 3012.

## AC Loading



\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

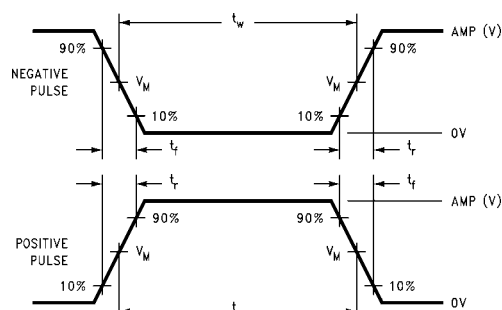


FIGURE 2.  $V_M = 1.5V$   
Input Pulse Requirements

| Amplitude | Rep. Rate | $t_w$  | $t_r$  | $t_f$  |
|-----------|-----------|--------|--------|--------|
| 3.0V      | 1 MHz     | 500 ns | 2.5 ns | 2.5 ns |

FIGURE 3. Test Input Signal Requirements

## AC Waveforms

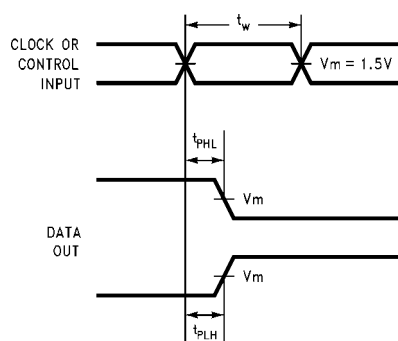


FIGURE 4. Propagation Delay,  
Pulse Width Waveforms

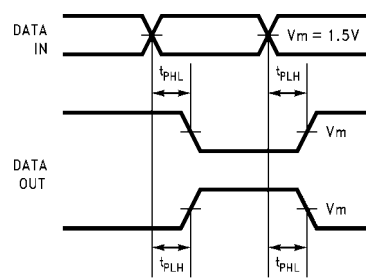


FIGURE 6. Propagation Delay Waveforms for  
Inverting and Non-Inverting Functions

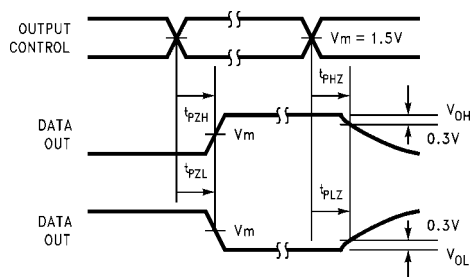


FIGURE 5. 3-STATE Output HIGH  
and LOW Enable and Disable Times

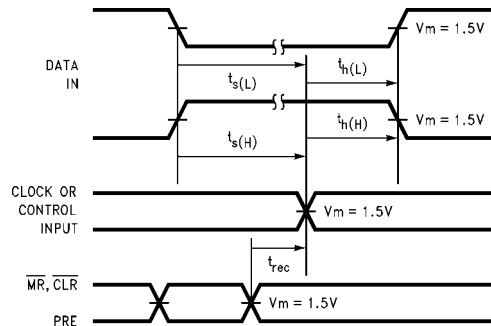
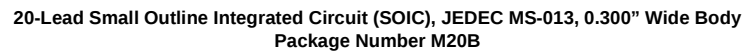


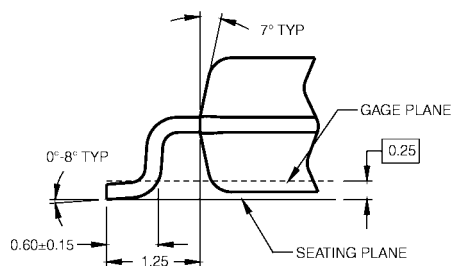
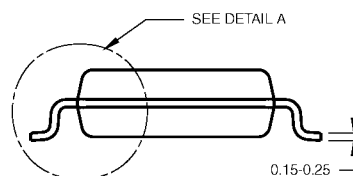
FIGURE 7. Setup Time, Hold Time  
and Recovery Time Waveforms



**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)

**LAND PATTERN RECOMMENDATION**


DIMENSIONS ARE IN MILLIMETERS

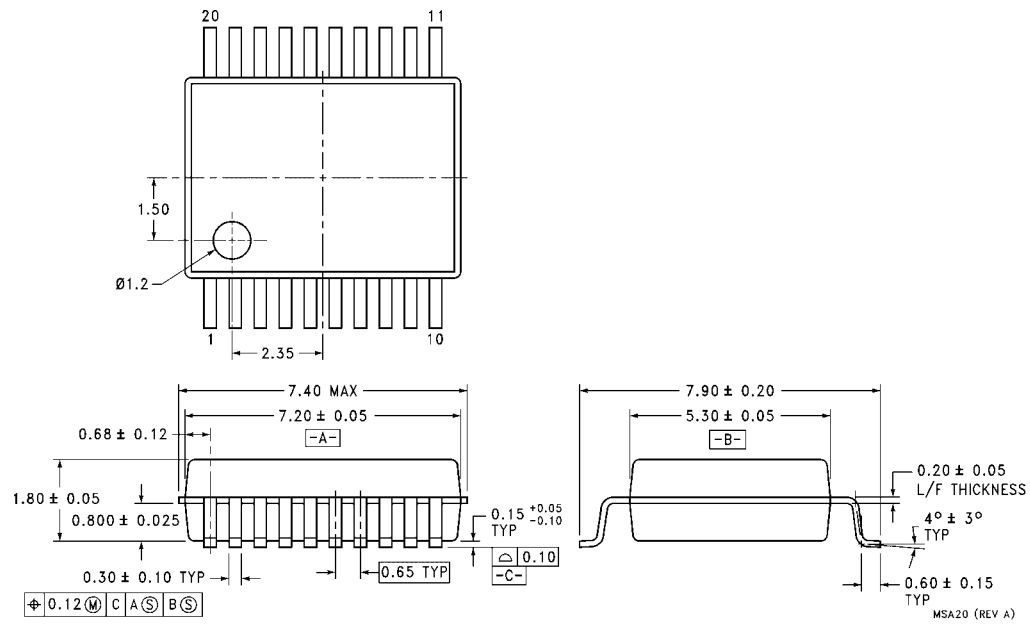

**DETAIL A**
**NOTES:**

- CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M20DRevB1

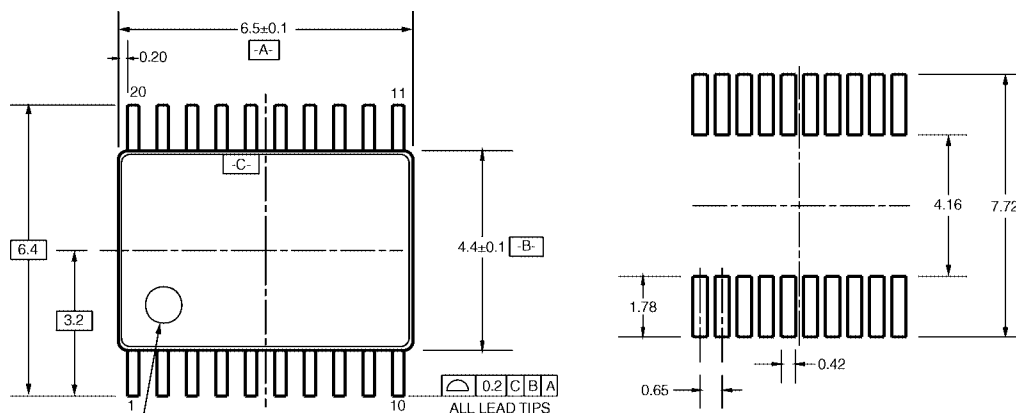
**20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide**  
**Package Number M20D**

# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

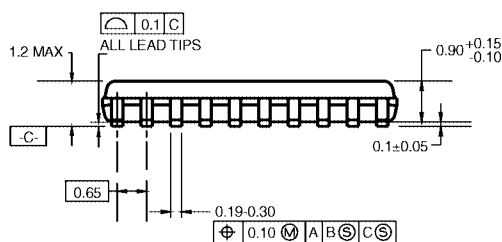


20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide  
Package Number MSA20

# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



LAND PATTERN RECOMMENDATION

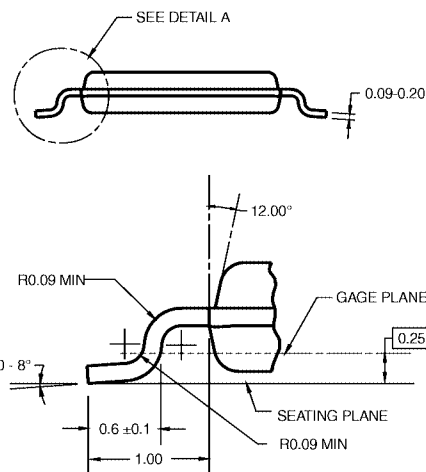


DIMENSIONS ARE IN MILLIMETERS

## NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20RevD1



DETAIL A

## 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide Package Number MTC20

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